

HGTD activities at USTC

USTC HGTD group

University of Science and Technology of China

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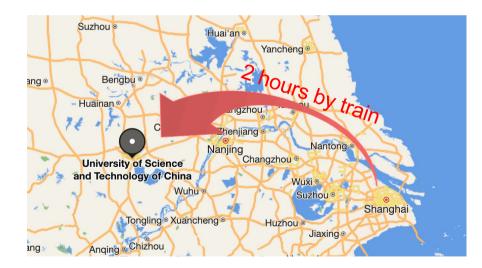
USTC HGTD group

Particle and Nuclear Physics

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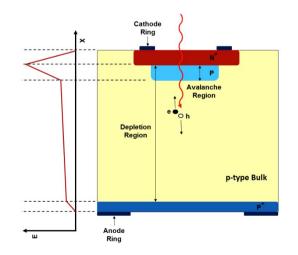


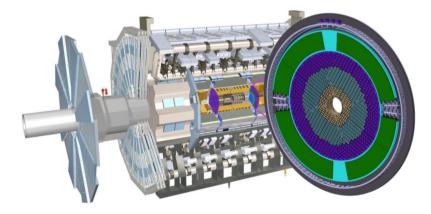




HGTD project at ATLAS and USTC involvement

- High Granularity Timing Detector (HGTD) is an upgrade project for HL-LHC (to be installed during 2026 – 2028) to mitigate the high pile-up running condition by adding timing info [TDR]
- Sensor technology: Low-Gain Avalanche Detector (LGAD), will be installed at 2.4< $|\eta|$ <4.0, time resolution per hit 35 ~ 70 ps up to NIEL of 2.5E15 cm⁻² Si 1 MeV n_{eq})
- USTC responsibilities in sensor and assembly RD: design and fabricate 10% of the sensors and assemble 10% of the detector modules



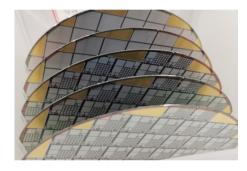


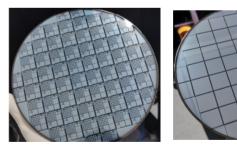
Planned installation location of HGTD in ATLAS

Illustration the LGAD technology

USTC LGAD RD milestones

- 2019. 7 first design completed
- 2019.9 initial discussion about the fabrication with Institute of Microelectronics (IME, CAS)
- 2020.7 delivery of USTC-IME-1.0 LGAD
- 2020.11 delivery of USTC-IME-1.1 LGAD
- 2021.5 2021.10 USTC-IME-2.0 production
- 2021.11 2021.12 USTC-IME-2.1 production
- Samples of all versions are extensively tested
 - Irradiated with reactor neutrons
 - Electrical properties characterized with probe station
 - Time resolution, efficiency and charge collection measured with infrared laser, beta source and test beams at DESY and CERN
- 2022.8 USTC-IME-2.x passed design specifications
 preparing for production

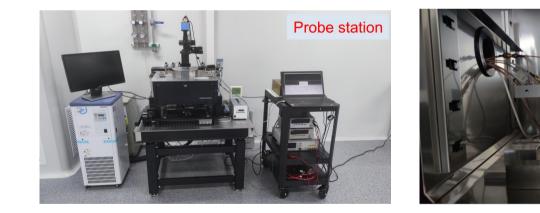




USTC lab resources for sensor tests

β-scope

- Probe station equipped with a cooling system
- Sr-90 beta-scope (inside an environment chamber)
- Infrared-laser TCT
- (a dedicated clean room of 270 m² for HGTD assembly)





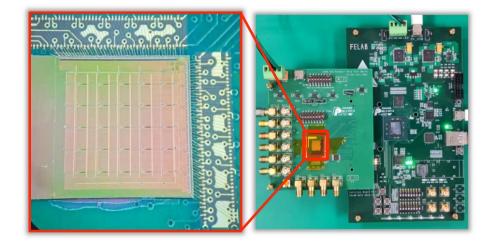
USTC Center for Micro-and Nanoscale Research and Fabrication

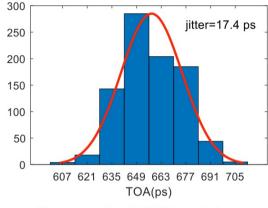
- Our work is strongly supported by the USTC NRFC that is equipped with devices for semi-conductor processing and testing housed in 3 clean rooms (surface:1200 m² in total)
 - e.g Lithography, etching, coating, dicing, wedge-bonding



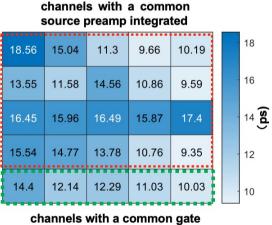
Readout ASIC for LGAD

- Working on the readout ASIC for LGAD, which will be bump bonded to sensors directly.
- The 1st version prototype ASIC has been tested:
 - 25 channels: 5 x 5 pixel matrix
 - Preamplifier, discriminator +TDC inside in the ASIC
 - Input charge: 5~40 fC
 - Time resolution: jitter < 25 ps @ 10 fC





Time resolution @ 10 fC input charge



common source preamps integrated

USTC HGTD team and the plan

- Faculty: Lei Zhao, Hao Liang, Yanwen Liu, Yongjie Sun, Yusheng Wu, Lailin Xu, Zhengguo Zhao
- Postdocs: Quanyin Li, Jiajin Ge*, Jiajun Qin
- Students: Yongkang Cai, Han Chen*, Chihao Li, Han Li, Kuo Ma, Tao Wang, Aonan Wang, Xiao Yang, De Zhang, Xiangxuan Zheng

Blue = detector

Red = electronics

* Members that have left

The plan:

- Thinking how to involve in EIC LGAD project: Sensor R&D and fabrications, ASIC, simulations ...
- Manpower and fundings